## In the Claims

The following listing of the claims replaces all previous listings.

## I.-29. (Canceled)

30. (Currently Amended) A compression molding composition for use in compression molding an article, said composition comprising:

an inorganic fiber, an inorganic binder, and a carrier solvent, wherein at least a portion of the inorganic binder is suspended in at least a portion of the carrier solvent;

wherein the composition comprises less than about 25 % by wt. inorganic fiber in an amount sufficient to be bound by the inorganic binder during the compression molding to form the article;

wherein the composition comprises in the range of about 15 to 35 % by wt. inorganic binder;

wherein the composition comprises in the range of about 15 to 45 % by wt. carrier solvent; and

wherein the composition comprises in the range of about 0 to 70 % by wt. additional solid additives.

## 31. (Canceled)

- 32. (Previously Presented) The composition of claim 30, wherein the additional additives include an inorganic filler, and the inorganic filler is in the range of 15 to 70 % by weight of the total composition.
- 33. (Previously Presented) The composition of claim 30, wherein the additional additives include an organic polymer, and the organic polymer is in the range of 0.1 to 0.5 % by weight of the total composition.
- 34. (Original) The composition of claim 33, wherein the organic polymer is an acrylic polymer.

- 35. (Previously Presented) The composition of claim 33, wherein the organic polymer acts as a molding thickener to help the composition hold shape when it is being molded.
- 36. (Original) The composition of claim 30, wherein the carrier solvent is water.
- 37. (Original) The composition of claim 36, wherein the composition has a moisture content in the range of 20 to 35% by weight of the total composition.
- 38. (Original) The composition of claim 37, wherein the composition has a moisture content 23 to 30% by weight of the total composition.
- 39. (Original) The composition of claim 38, wherein the composition has a moisture content in the range of 25 to 27% by weight of the total composition.
- 40. (Previously Presented) The composition of claim 30, wherein the inorganic binder is colloidal silica.
- 41. (Currently Amended) The composition of claim 30, wherein the composition is less than about 10 % by wt. inorganic fiber.
- 42. (Currently Amended) The composition of claim 41, wherein the composition is less than about 5 % by wt. inorganic fiber.
- 43. (Currently Amended) The composition of claim 30, wherein the composition is in the range of about 20 to 30 % by wt. inorganic binder.
- 44. (Currently Amended) The composition of claim 30, wherein the composition is in the range of about 20 to 40 % by wt. carrier solvent.

45. (Currently Amended) The composition of claim 44, wherein the composition is in the range of about 25 to 35 % by wt. carrier solvent.